NO. 8318 P. 3 # 20/E

Docket No. 0756-2306 9/1/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)	Art Unit: 2813
Taketomi ASAMI et al.)	Examiner: D. Blum
Serial No. 09/842,315)	CERTIFICATE OF MAILING
Filed: April 26, 2001)	I hereby certify that this correspondence is being deposited with The United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on YV442-03
For: MANUFACTURING METHOD)	
FOR SEMICONDUCTOR)	
DEVICE	١	

SUPPLEMENTAL AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Further to the Amendment filed on May 12, 2003, please amend the aboveidentified application as follows:

IN THE CLAIMS:

Please amend claims 12 as follows:

12. (Amended) A method for a semiconductor device according to claim 4, wherein [said surface is etched with an acid solution which includes fluorine after washing with pure water in which ozone is dissolved in said second step] the water comprises ozone at a concentration of 6 mg/L or more.

This will acknowledge receipt of the following:

1. Supplemental Amendment

2. Certificates of Mailing for each of the above

In re PATENT application of:

FAKETOMI ASAMI et al Serial No. 09/842,315 Filed: 04/26/2001 Due Date: 05/27/2003

For: MANUFACTURING METHOD FOR-SEMICONDUCTOR DEVICE

Docket: 0756-2306 May 37.03 EIR/am MAY 3 0 2003 W

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FACSIMILE COVER SHEET

To: Ex. David S. Blum	From: Eric J. Robinson
Facsimile Number: 703 746 3870	Telephone No.
Number of Pages (including cover sheet):	18

Re: U.S. Patent Application Serial No. 09/842,315

For: Manufacturing Method for Semiconductor Device

Our Reference: 0756-2306

Attached please find copies of the Amendment filed on May 12, 2003 and Supplemental Amendment filed on May 27, 2003. If I can be of further assistance, please do not hesitate to contact me.